# WELLCOMP TECHNOLOGY CO., LTD

### APPROVAL SHEET

Model Name	Metal Strip Current Sensing Resistor
Part Number	WMCSH0603R010FSTx
Customer Name	
Customer P/N	
Issued Date	

Customer		Maker			
Approved	Checked	Inspector	Checked	Prepared	



### 元璽科技股份有限公司

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**Metal Strip Current Sensing Resistor** 

Document No: 20120803001 Issued Date: 2012/08/03

Version: A01

#### **Features**

- ◆Able to withstand high temperature and high current
- ◆Ultra Low sensing resistance
- ◆Excellent frequency response
- ♦Chip size: 0805
- Lead free, RoHS compliant for global applications and halogen free

### **Application**

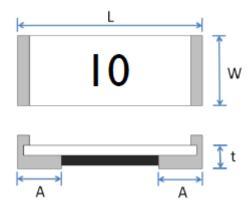
- ◆Mobile electronic equipment-Cellular phone, NB Tablet PC, GPS, DSC, HDD
- ◆DC-DC converter, Adapter, Battery pack and charger
- ◆Switching power supply
- ♦Voltage Regulation module
- ◆Power management applications

### **Part Numbering System**

### WMCSH 0603 R010 F S T A

- (1) (2) (3) (4) (5) (6) (7)
- (1) Series Code
- (2) Size (EIA): Length x Width
- (3) Resistance: R002=2m  $\Omega$ , R009=9m  $\Omega$
- (4) Tolerance: F=+/-1%, G=+/-2%, J=+/-5%
- (5) Power Rating: A=1/4W S=1/2W, C=1W, D=1.5W, E=2W
- (6) Packaging: T- Embossed paper tape, 7" reel E-Embossed plastic tape, 7" reel
- (7) Factory Code, A=Taiwan Factory

### **Dimension**



Туре	Dimensions(mm)				
(inch size)	L	W	t	Α	
WMCSH0603	1.60±0.10	0.80±0.1	0.55±0.15	0.30±0.20	



**Metal Strip Current Sensing Resistor** 

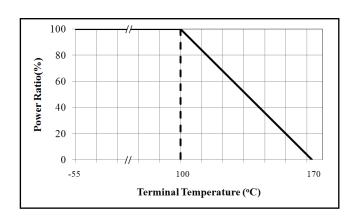
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### **Electrical Specification**

Item	Power Rating	Resistance Range(m $\Omega$ )	Operation Temp. Range	TCR (PPM/°C)
MCSH0603	1/2W	10	-55~+170°C	±75

### **Derating Curve**



### **Performances**

### **Environmental Performance**

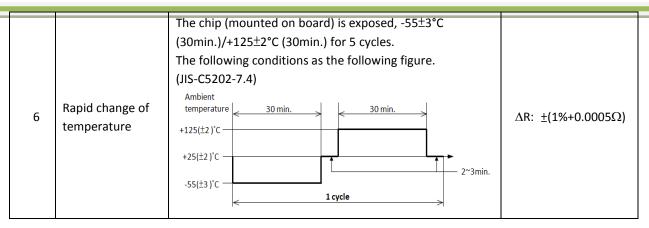
No.	Item	Test Condition	Specification
1	Short Time Overload	Voltage equal to 5 time rated power for 5 sec, (JIS-C5202-5.5)	$\Delta$ R: ±(1%+0.0005Ω)
2	Temperature Coefficient of Resistance (T.C.R.)	+25°C/+125°C. (JIS-C5202-5.2) $TCR \text{ (ppm/°C)} = \frac{\Delta R}{R \times \Delta t} \times 10^{6}$	Refer to Electrical Specification
3	Damp Heat with Load	The specimens shall be placed in a chamber and subjected to a relative humidity of 90~95% percent and a temperature of 40° ±2°C for the period of 1000 hrs. (MIL-STD-202, Method 103)	$\Delta$ R: ±(1%+0.0005Ω)
4	High Temperature Exposure	The ship (mounted on board) is exposed in the heat chamber 125 $\pm 3^{\circ}$ C for 1000 hrs. (JIS-C5202-7.2)	$\Delta$ R: ±(1%+0.0005Ω)
5	Load Life	Apply rated power at 70±2°C for 1000 hours with 1.5 hours ON and 0.5 hour OFF. (JIS-C5202-7.10)	ΔR: ±(1%+0.0005Ω)



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### **Function Performance**

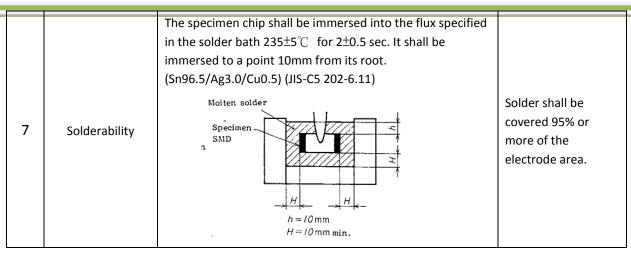
No.	Item	Test Condition	Specification
1	Bending Strength	Mount the chip to test substrate. Apply pressure in direction of arrow unit band width reaches 2mm(+0.2/-0mm) illustrated in the figure below and hold for 10±1 sec. (JIS-C5202-6.1)  Unit: mm  Position before bend  Testing printed circuit board	$\Delta$ R: ±(1%+0.0005Ω)
5	Solvent Resistance	The chip is completed immersion of the specimens in the isopropyl alcohol for 3 *+5, -0) min., 25°C ±5°C. ((MIL-STD-202, Method 215)	Verify marking permanency. (Nor required for laser etched parts or parts with no marking)
6	Resistance to solder Heat	The specimen chip shall be immersed into the flux specified in the solder bath $260\pm5^{\circ}$ C for $10\pm1$ sec. (MIL-STD-202, Method 210)	$\Delta$ R: ±(1%+0.0005Ω)



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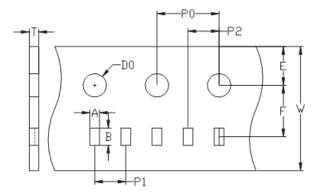


#### Remark:

- a. 0.5 W with total solder pad trace size of 100 mm<sup>2</sup>.
- b. 1.0 W with total solder pad trace size of 100 mm<sup>2</sup>.
- c. 1.5 W with total solder pad trace size of 200 mm<sup>2</sup>.
- d. 2.0 W with total solder pad trace size of 300 mm<sup>2</sup>.

### **Tape Packaging Specifications**

◆Paper Tape Specifications



Unit:mm

Tyne	Carrier Dimensions									
Type	Α	В	E	F	W	P0	P1	P2	D0	Т
0603	1.1±0.1	1.9 <u>±</u> 0.1	1.75±0.1	3.5±0.05	8.0±0.2	4.0±0.1	4.0±0.1	2.0±0.05	1.55±0.05	0.70±0.1

### **Packaging**

Size EIA (EIAJ)	0603
Standard Packing Quantity (pcs /reel)	5,000



**Metal Strip Current Sensing Resistor** 

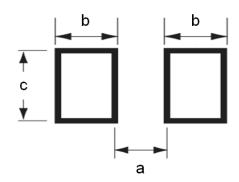
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### **Storage Conditions**

Temperature :  $5^{\circ}35^{\circ}$ C, Humidity :  $40^{\circ}75\%$ 

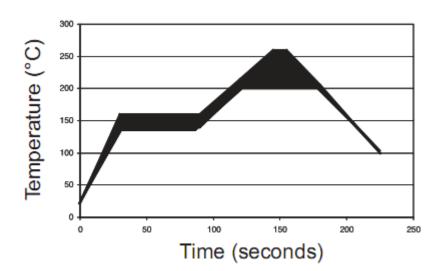
### **Recommended Solder Pad Layout**



Туре	Pad Layout Dimension (mm)				
Туре	a	b	С		
0603	0.90	0.70	1.00		

### **Soldering Recommendations**

- ◆ Peak reflow temperatures and durations:
  - IR Reflow Peak =  $260^{\circ}$ C max for 10 sec
  - Wave Solder = 260°C max for 10 sec
- ◆ Compatible with lead and lead-free solder reflow processes
- ◆ Recommended IR Reflow Profile:



### **ECN**

Engineering Change Notice: The customer will be informed with ECN if there is significant modification on the characteristics and materials described in Approval Sheet.